



30V NP-Channel Trench Power MOSFET

General Description

The SJM30NP200 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

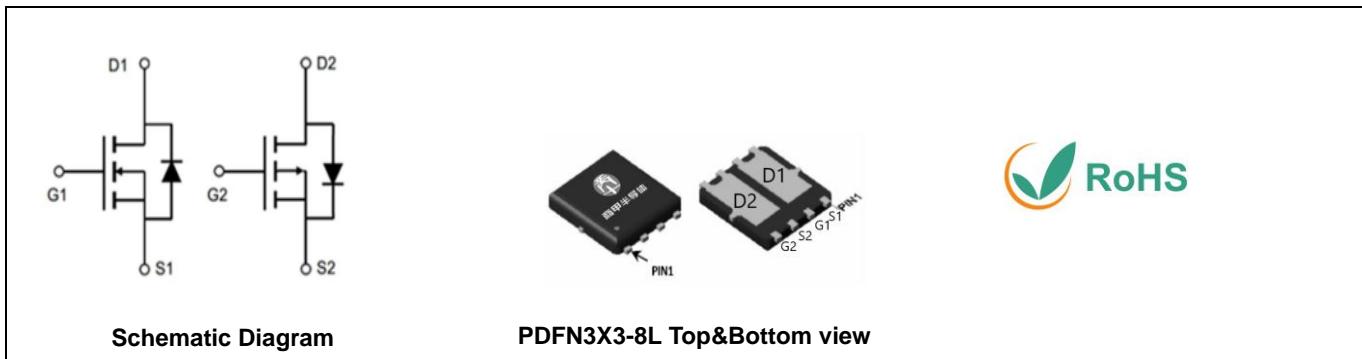
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Value	Unit
V_{DS}	30	-30	V
$R_{DS(ON)}_{TYP}$	7.6	12.3	mΩ
I_D	45	-37	A
Q_G	21.2	38	nC

**Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM30NP200	SJM30NP200	PDFN3X3-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	N Limit	P Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	30	-30	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	45	-37	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	28	-23	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	180	-148	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	30	34	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	12	13.5	W
E_{AS}	Avalanche energy (Note 2)	72	100	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150		°C

Table 2. Thermal Characteristic

Symbol	Parameter	N Limit	P Limit	Unit
$R_{θJC}$	Thermal Resistance, Junction-to- Case	4.19	3.7	°C/W



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Table 3. N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V} T_J=25^\circ\text{C}$			1	μA
		$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V} T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1		2.5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=4\text{A}$		15.7		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=4\text{A} T_J=25^\circ\text{C}$		7.6	9.5	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=3\text{A} T_J=25^\circ\text{C}$		12.3	15.4	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		1062		pF
C_{oss}	Output Capacitance			130		pF
C_{rss}	Reverse Transfer Capacitance			114		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1.0\text{MHz}$		1.53		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=15\text{V}, R_L=5\Omega, R_{\text{GEN}}=3\Omega$		6.4		nS
t_r	Turn-on Rise Time			346		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			19.4		nS
t_f	Turn-Off Fall Time			9.8		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V}, I_{\text{D}}=4\text{A}$		21.2		nC
Q_{gs}	Gate-Source Charge			2.32		nC
Q_{gd}	Gate-Drain Charge			4.24		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				45	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=4\text{A}$			1.2	V

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

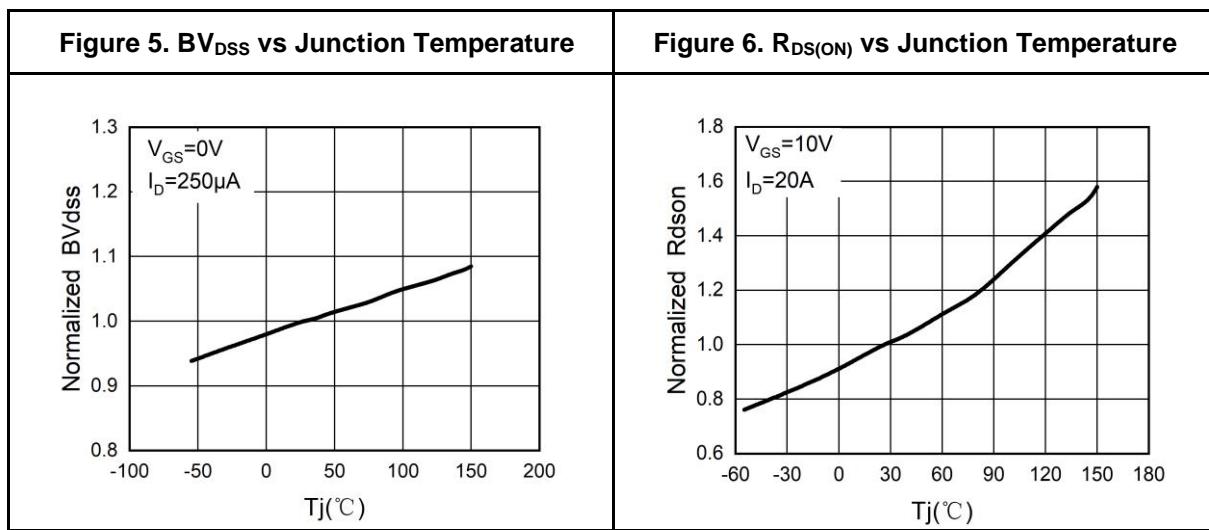
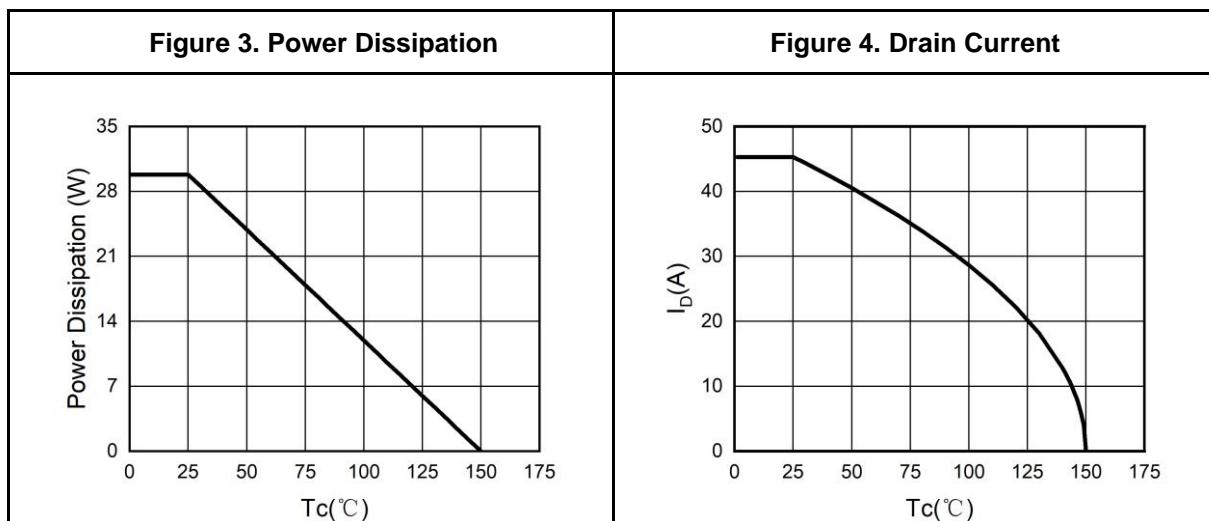
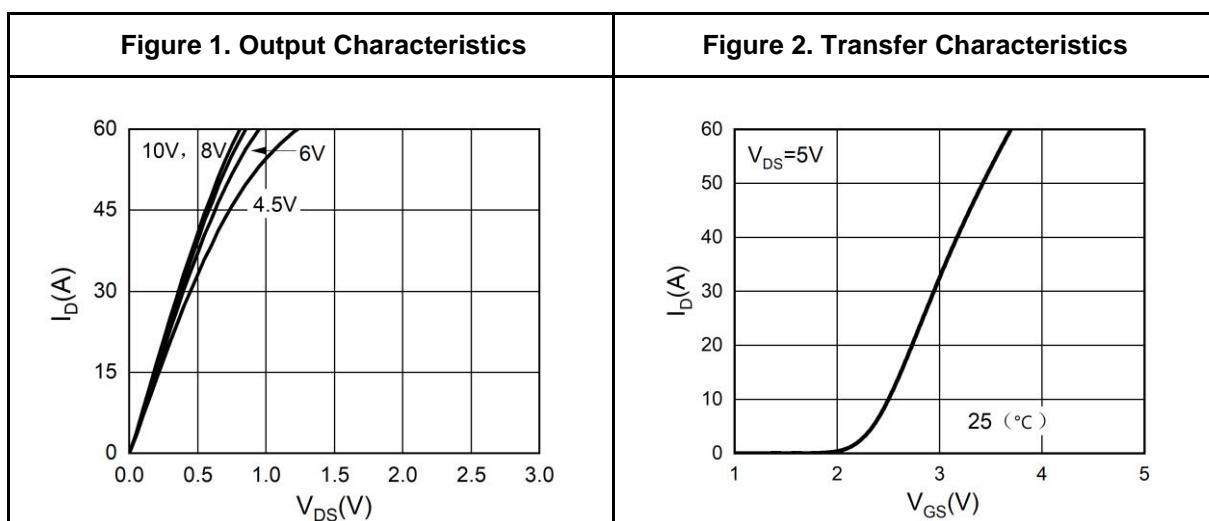
Notes 2.E_AS condition: $T_J=25^\circ\text{C}, V_{\text{DD}}=30\text{V}, V_{\text{G}}=10\text{V}, R_g=25\Omega, L=0.5\text{mH}$.

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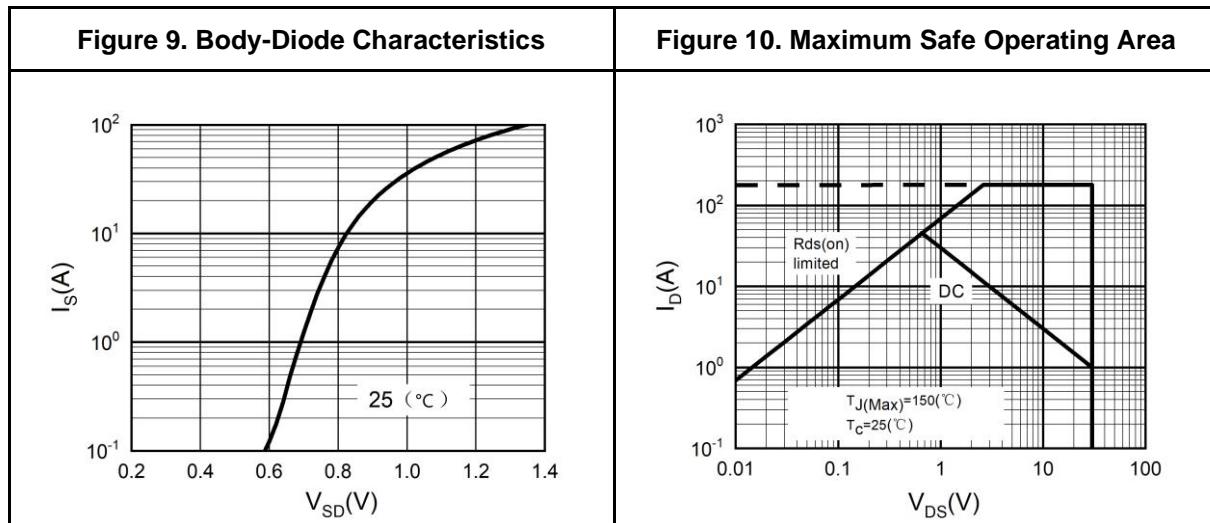
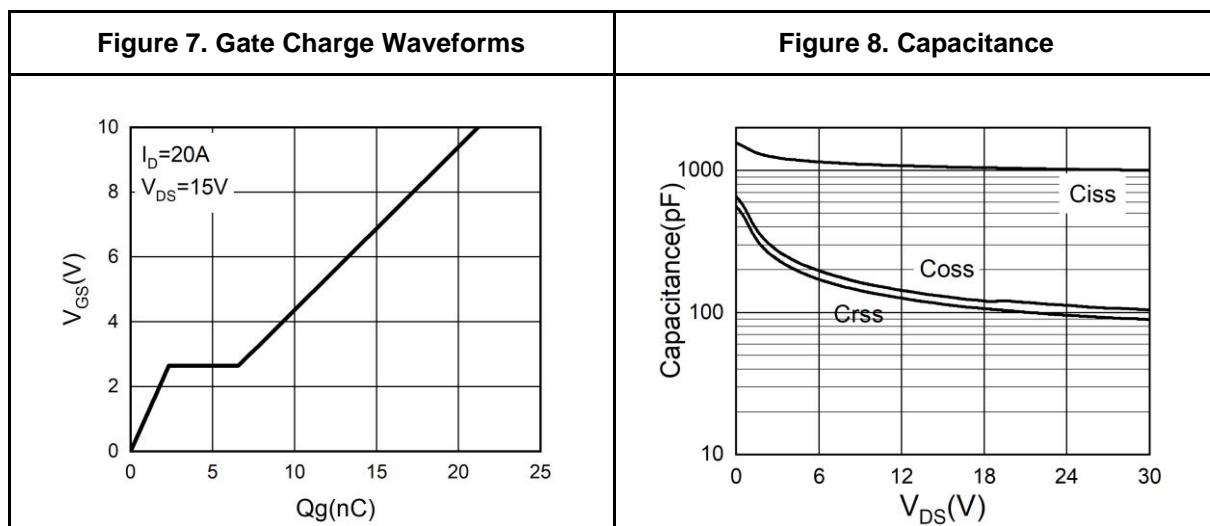
N-Channel Typical Electrical And Thermal Characteristics (Curves)





30V NP-Channel Trench Power MOSFET

N-Channel Typical Electrical And Thermal Characteristics (Curves)





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Table 4. P-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V} T_J=25^\circ\text{C}$			-1	μA
		$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V} T_J=125^\circ\text{C}$			-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1		-2.5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-5\text{A}$		8.1		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-5\text{A} T_J=25^\circ\text{C}$		11	14.3	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-4\text{A} T_J=25^\circ\text{C}$		16.6	21.6	$\text{m}\Omega$
Dynamic Characteristics2						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		1470		pF
C_{oss}	Output Capacitance			165		pF
C_{rss}	Reverse Transfer Capacitance			131		pF
				13		
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-15\text{V}, R_{\text{L}}=3\Omega, R_{\text{GEN}}=3\Omega$		14.6		nS
t_{r}	Turn-on Rise Time			3		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			91.2		nS
t_{f}	Turn-Off Fall Time			35.6		nS
Q_{g}	Total Gate Charge	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-15\text{V}, I_{\text{D}}=-5\text{A}$		38		nC
Q_{gs}	Gate-Source Charge			8		nC
Q_{gd}	Gate-Drain Charge			9		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				-37	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-5\text{A}$			-1.2	V

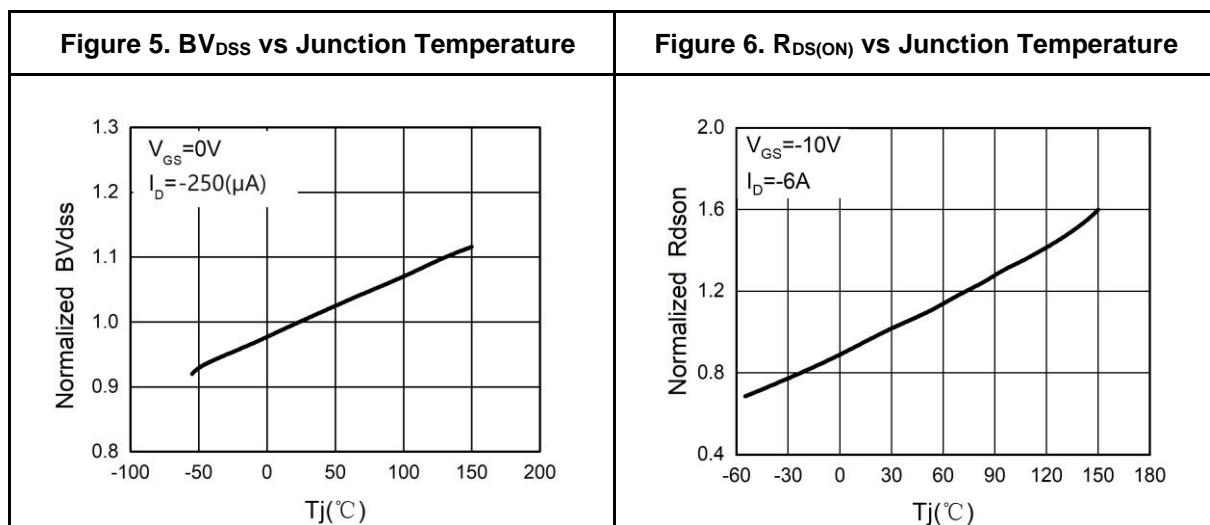
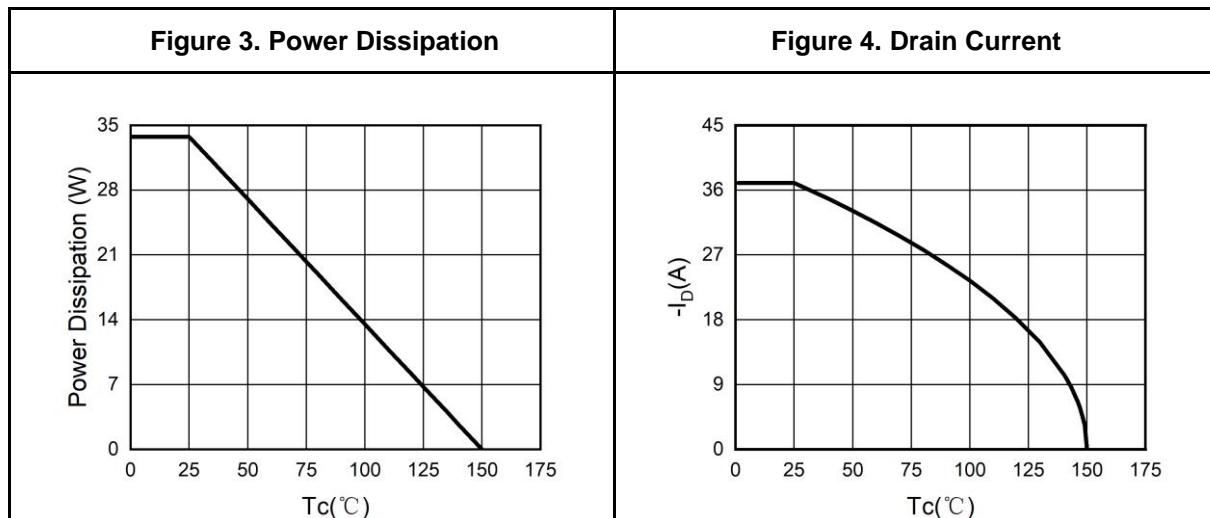
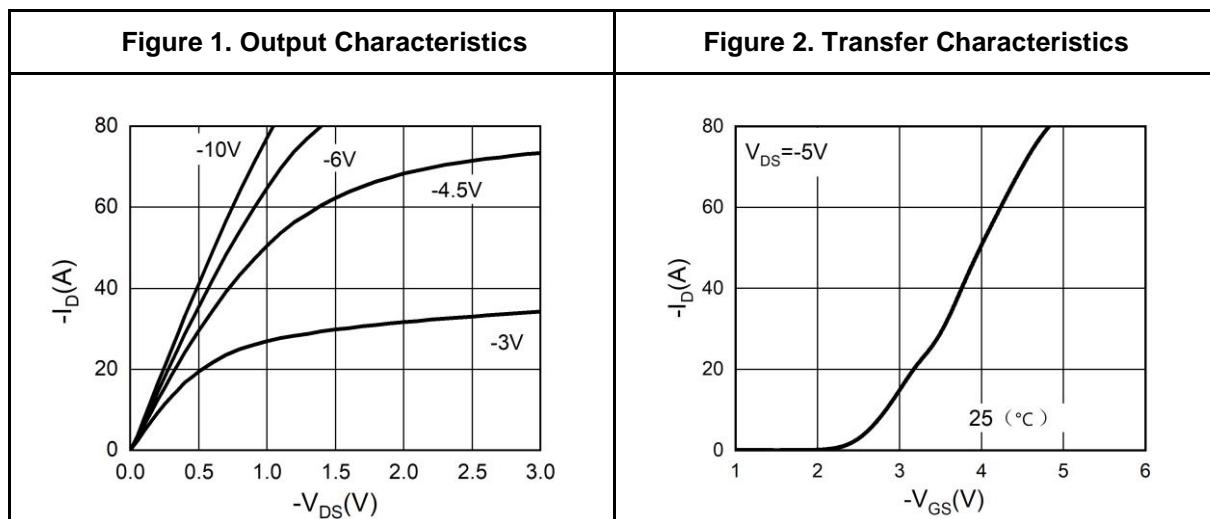
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}, V_{\text{DD}}=-30\text{V}, V_{\text{G}}=-10\text{V}, R_{\text{g}}=25\Omega, L=0.5\text{mH}$.

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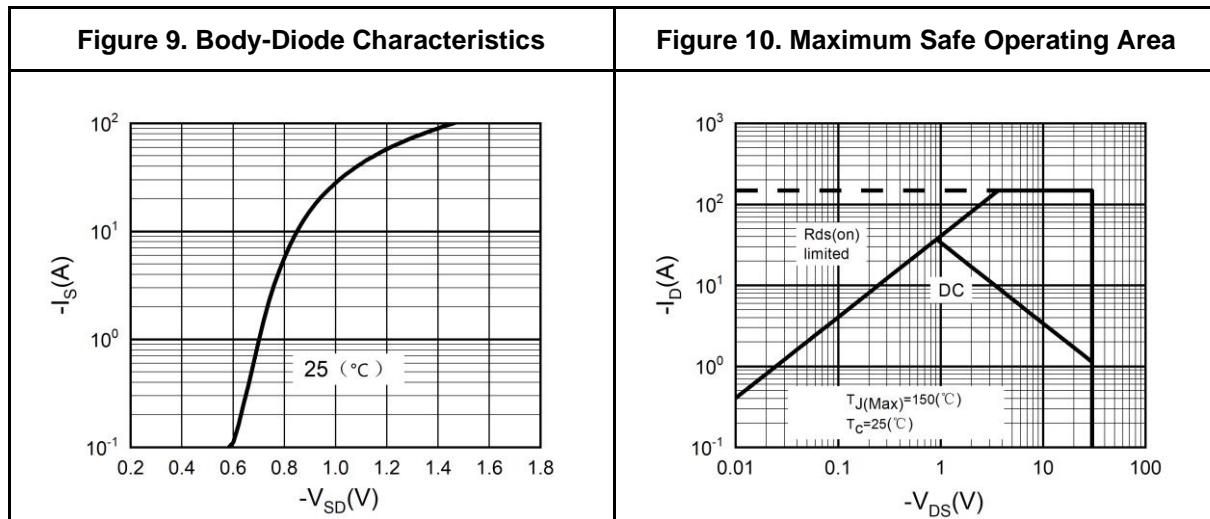
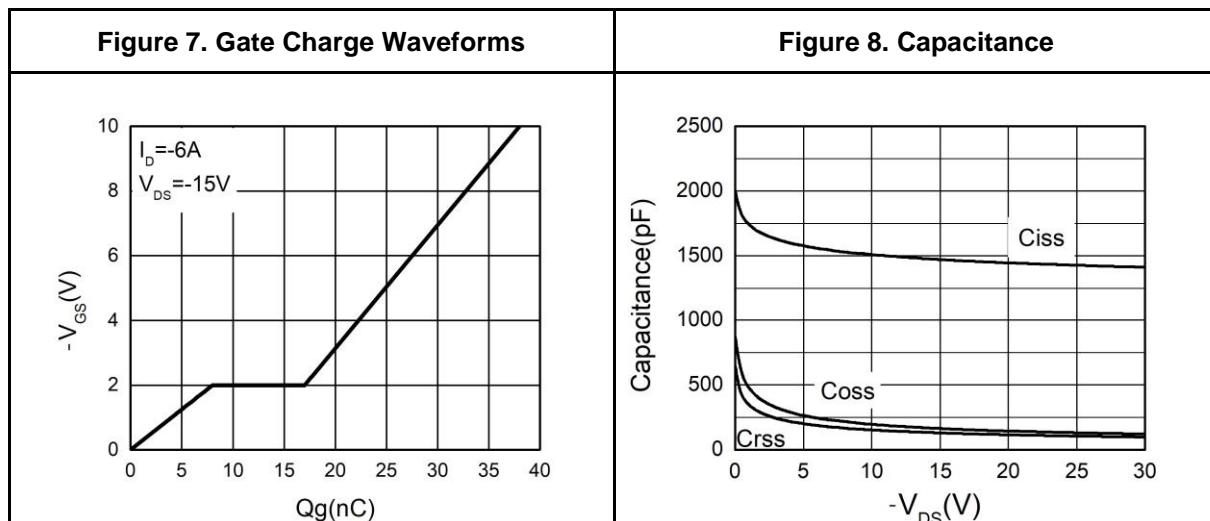


P-Channel Typical Electrical And Thermal Characteristics (Curves)



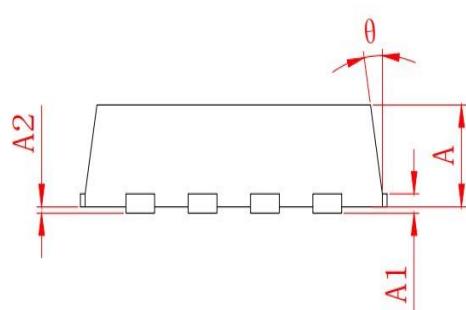
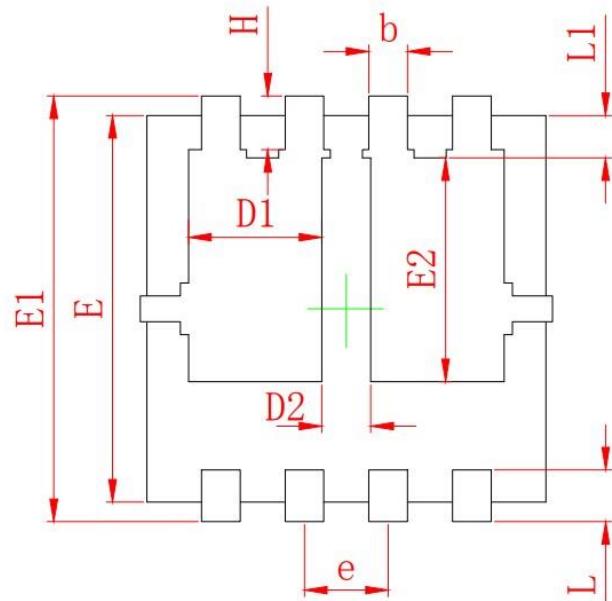
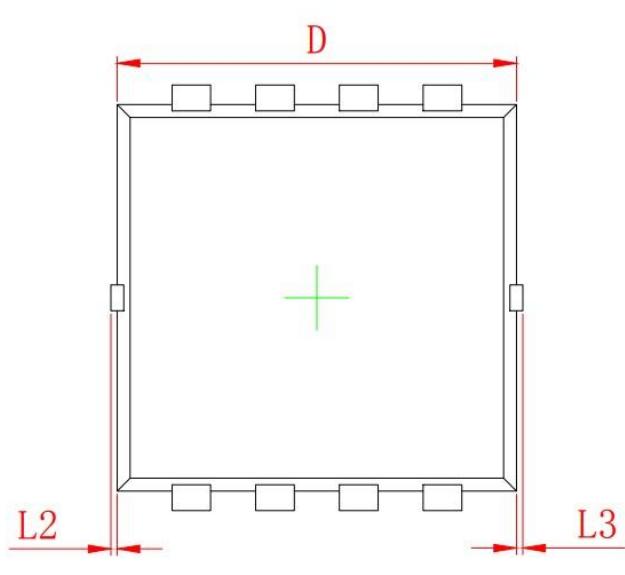


P-Channel Typical Electrical And Thermal Characteristics (Curves)





PDFN3X3-8L Package Information



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.700	0.900
A1	0.152 REF.	
A2	0~0.05	
D	3.000	3.200
D1	0.935	1.135
D2	0.280	0.480
E	2.900	3.100
E1	3.150	3.450
E2	1.535	1.935
b	0.200	0.400
e	0.550	0.750
L	0.300	0.500
L1	0.180	0.480
L2	0~0.100	
L3	0~0.100	
H	0.315	0.515
θ	8°	12°



Attention

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